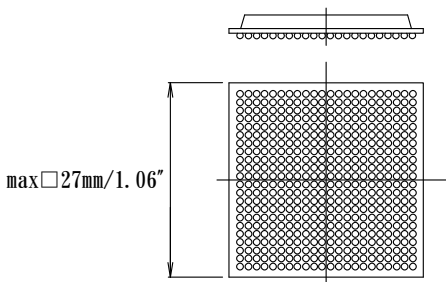


**Test & Burn-In Socket, GU66 molded frame series**  
**Size 58x66mm / 2.29x2.60"**

- Features:
- High reliability
  - Cost competitive
  - Short delivery time
  - Temperature  
-40°C to +150°C  
(typical)

● Acceptable device size



max □ 27mm/1.06"

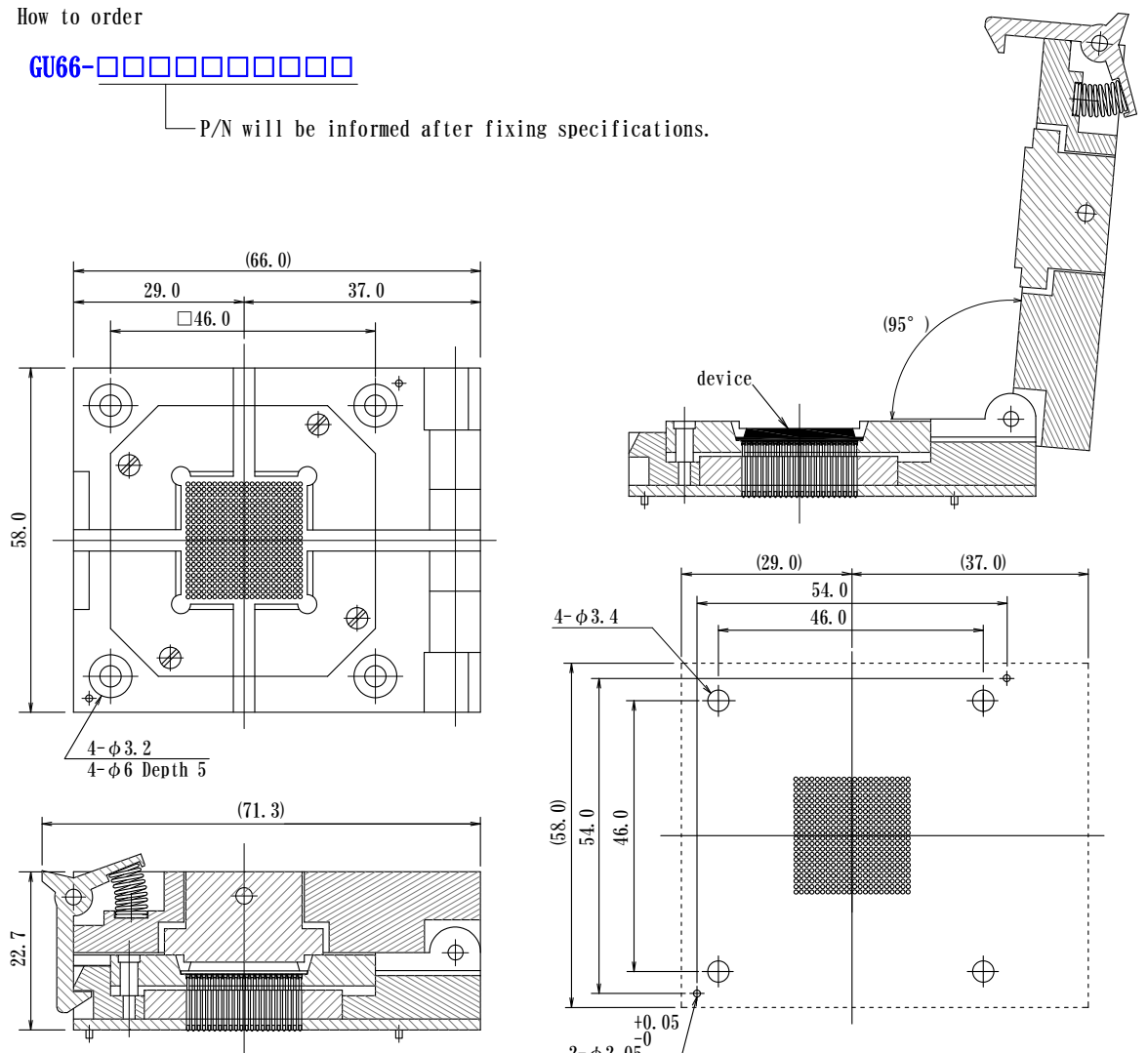
In the case of larger size, consult factory.  
Any device on 0.30mm pitch or larger



How to order

**GU66-□□□□□□□□□□**

P/N will be informed after fixing specifications.



Top View Dimensions:  
 Total width: 66.0  
 Left section: 29.0  
 Right section: 37.0  
 Device area width: 46.0  
 Total height: 58.0  
 4-φ 3.2  
 4-φ 6 Depth 5

Side View Dimensions:  
 Total height: 71.3  
 Device height: 22.7

Cross-sectional View:  
 Device  
 (95°)  
 4-φ 3.4  
 2-φ 2.05 (+0.05/-0)  
 PCB Pattern (Top View)  
 Dimensions: 29.0, 54.0, 37.0, 58.0, 54.0, 46.0

mm